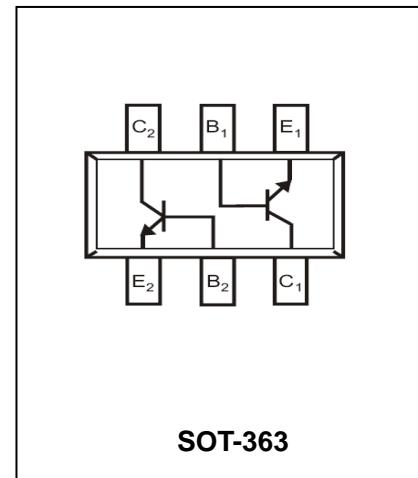


Dual NPN Small Signal Surface Mount Transistor

FEATURES

- Epitaxial planar die construction.
- Ideal for low power amplification and switching.
- Ultra-small surface mount package
- Also available in lead free version.



APPLICATIONS

- General switching and amplification

MAXIMUM RATING @ Ta=25°C unless otherwise specified

SYMBOL	PARAMETER	VALUE	UNIT
V _{CBO}	collector-base voltage	60	V
V _{CEO}	collector-emitter voltage	40	V
V _{EBO}	emitter-base voltage	6	V
I _C	collector current -continuous	0.2	A
P _{tot}	total power dissipation	0.2	W
R _{θJA}	Thermal Resistance, Junction to Ambient	625	°C/W
T _{stg}	storage temperature	150	°C
T _j	junction temperature	-55 to +150	°C

ELECTRICAL CHARACTERISTICS @ $T_a=25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{(BR)CBO}$	Collector-base breakdown voltage	$I_C=10\mu\text{A}, I_E=0$	60		V
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C=1\text{mA}, I_B=0$	40		V
$V_{(BR)EBO}$	Emitter-base breakdown voltage	$I_E=10\mu\text{A}, I_C=0$	5		V
I_{CEX}	collector cut-off current	$V_{CE}=30\text{V}, V_{EB(OFF)}=3.0\text{V}$	-	50	nA
I_{BL}	Base cut-off current	$V_{CE}=30\text{V}, V_{EB(OFF)}=3.0\text{V}$	-	50	nA
h_{FE}	DC current gain	$V_{CE}=1\text{V}, I_C=0.1\text{mA}$	40	-	
		$V_{CE}=1\text{V}, I_C=1\text{mA}$	70	-	
		$V_{CE}=1\text{V}, I_C=10\text{mA}$	100	300	
		$V_{CE}=1\text{V}, I_C=50\text{mA}$	60	-	
		$V_{CE}=1\text{V}, I_C=100\text{mA}$	30	-	
$V_{CE(\text{sat})}$	collector-emitter saturation voltage	$I_C=10\text{mA}, I_B=1\text{mA}$	-	200	mV
		$I_C=50\text{mA}, I_B=5\text{mA}$	-	300	mV
$V_{BE(\text{sat})}$	base-emitter saturation voltage	$I_C=10\text{mA}, I_B=1\text{mA}$	650	850	mV
		$I_C=50\text{mA}, I_B=5\text{mA}$	-	950	mV
C_{obo}	Output capacitance	$I_E=0, V_{CB}=5\text{V}, f=1\text{MHz}$	-	4	pF
C_{ibo}	Input capacitance	$I_C=0, V_{EB}=0.5\text{V}, f=1\text{MHz}$	-	8	pF
f_T	transition frequency	$I_C=10\text{mA}, V_{CE}=20\text{V}, f=100\text{MHz}$	300	-	MHz
NF	noise figure	$I_C=0.1\text{mA}, V_{CE}=5\text{V}, R_S=1\text{k}\Omega, f=1\text{kHz}$	-	5	dB
t_d	delay time	$V_{CC}=3\text{V}, V_{BE(\text{off})}=-0.5\text{V}$	-	35	ns
t_r	rise time		-	35	ns
t_s	storage time	$V_{CC}=3\text{V}, I_C=10\text{mA}$	-	200	ns
t_f	fall time		-	50	ns

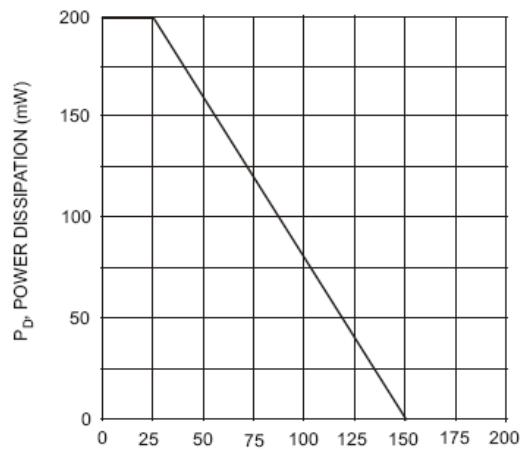
TYPICAL CHARACTERISTICS @ $T_a=25^\circ\text{C}$ unless otherwise specified

Fig. 1. Max Power Dissipation vs.
Ambient Temperature

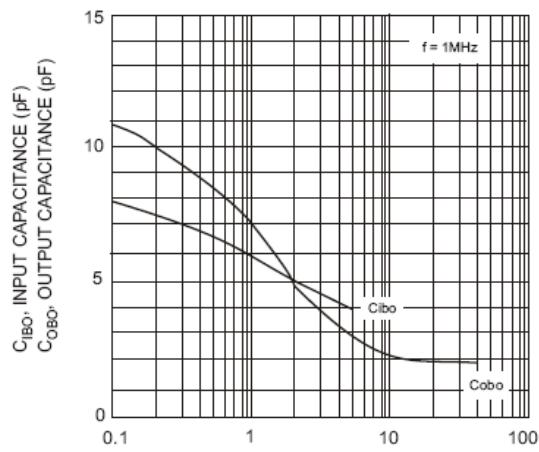
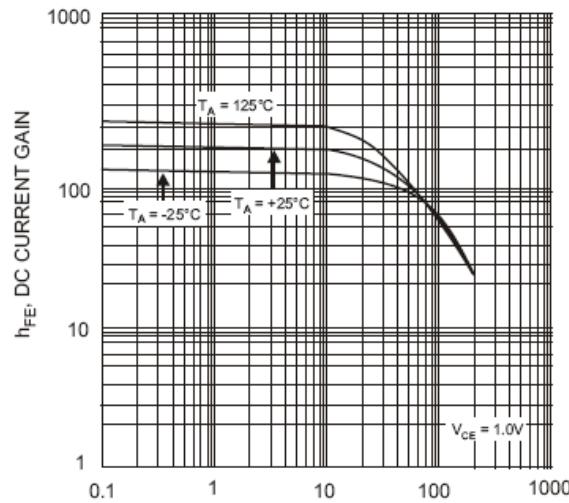
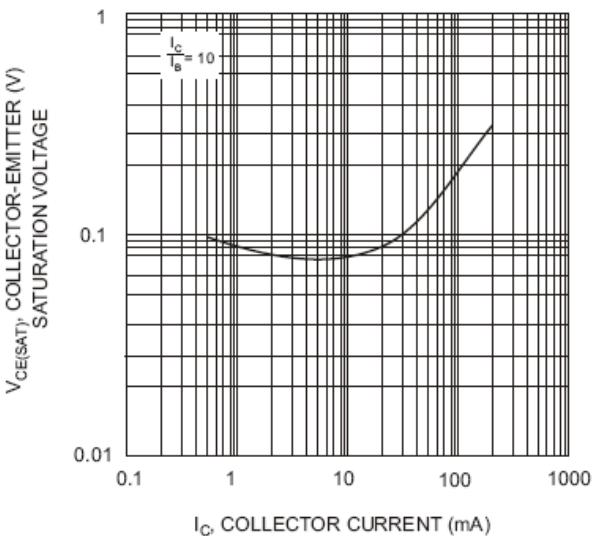


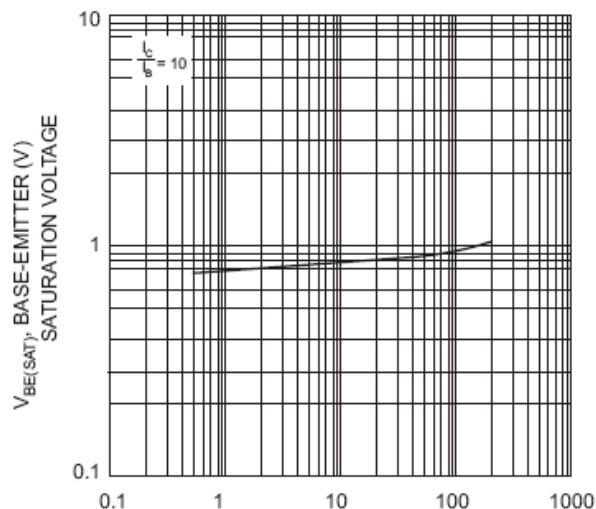
Fig. 2. Input and Output Capacitance vs.
Collector-Base Voltage



I_C, COLLECTOR CURRENT (mA)
Fig. 3, Typical DC Current Gain vs
Collector Current



I_C, COLLECTOR CURRENT (mA)
Fig. 4, Typical Collector-Emitter
Saturation Voltage vs. Collector Current

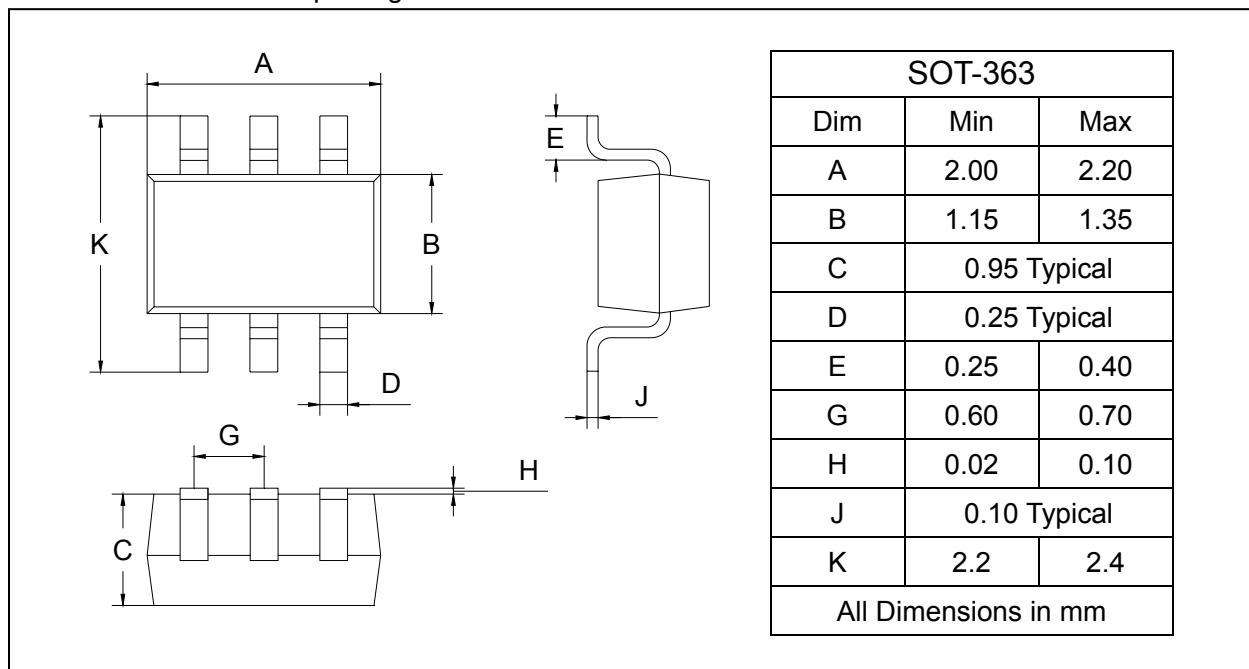


I_C, COLLECTOR CURRENT (mA)
Fig. 5, Typical Base-Emitter
Saturation Voltage vs. Collector Current

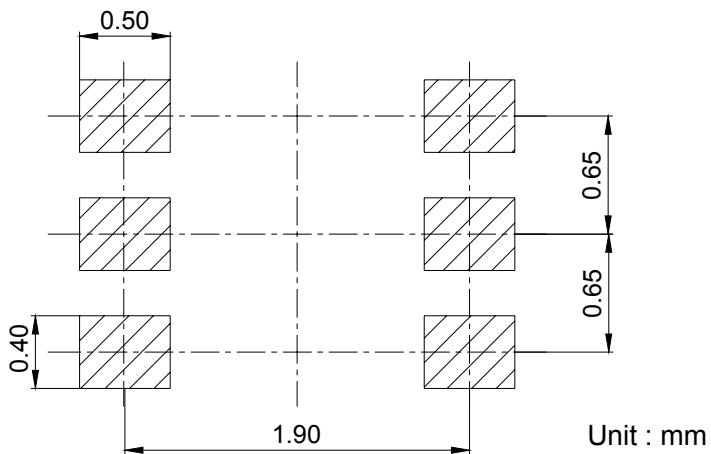
PACKAGE OUTLINE

Plastic surface mounted package

SOT-363



SOLDERING FOOTPRINT



PACKAGE INFORMATION

Device	Package	Shipping
MMDT3904	SOT-363	3000/Tape&Reel